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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	C166
Core Size	16-Bit
Speed	20MHz
Connectivity	CANbus, EBI/EMI, SPI, SSC, UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	59
Program Memory Size	64KB (64K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	4.75V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	80-QFP
Supplier Device Package	PG-MQFP-80-7
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/c164ci8emdbfxqma1

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16-Bit Single-Chip Microcontroller **C164CI**
C166 Family

C164CI/SI, C164CL/SL

- High Performance 16-bit CPU with 4-Stage Pipeline
  - 80 ns Instruction Cycle Time at 25 MHz CPU Clock
  - 400 ns Multiplication (16 × 16 bit), 800 ns Division (32 / 16 bit)
  - Enhanced Boolean Bit Manipulation Facilities
  - Additional Instructions to Support HLL and Operating Systems
  - Register-Based Design with Multiple Variable Register Banks
  - Single-Cycle Context Switching Support
  - 16 MBytes Total Linear Address Space for Code and Data
  - 1024 Bytes On-Chip Special Function Register Area
- 16-Priority-Level Interrupt System with 32 Sources, Sample-Rate down to 40 ns
- 8-Channel Interrupt-Driven Single-Cycle Data Transfer Facilities via Peripheral Event Controller (PEC)
- Clock Generation via on-chip PLL (factors 1:1.5/2/2.5/3/4/5), via prescaler or via direct clock input
- On-Chip Memory Modules
  - 2 KBytes On-Chip Internal RAM (IRAM)
  - 2 KBytes On-Chip Extension RAM (XRAM)
  - up to 64 KBytes On-Chip Program Mask ROM or OTP Memory
- On-Chip Peripheral Modules
  - 8-Channel 10-bit A/D Converter with Programmable Conversion Time down to 7.8 µs
  - 8-Channel General Purpose Capture/Compare Unit (CAPCOM2)
  - Capture/Compare Unit for flexible PWM Signal Generation (CAPCOM6) (3/6 Capture/Compare Channels and 1 Compare Channel)
  - Multi-Functional General Purpose Timer Unit with 3 Timers
  - Two Serial Channels (Synchronous/Asynchronous and High-Speed-Synchronous)
  - On-Chip CAN Interface (Rev. 2.0B active) with 15 Message Objects (Full CAN/Basic CAN)
  - On-Chip Real Time Clock
- Up to 4 MBytes External Address Space for Code and Data
  - Programmable External Bus Characteristics for Different Address Ranges
  - Multiplexed or Demultiplexed External Address/Data Buses with 8-Bit or 16-Bit Data Bus Width
  - Four Optional Programmable Chip-Select Signals
- Idle, Sleep, and Power Down Modes with Flexible Power Management
- Programmable Watchdog Timer and Oscillator Watchdog
- Up to 59 General Purpose I/O Lines, partly with Selectable Input Thresholds and Hysteresis

Table 2 Pin Definitions and Functions

Symbol	Pin No.	Input Outp.	Function		
P5		I	Port 5 is an 8-bit input-only port with Schmitt-Trigger charact. The pins of Port 5 also serve as analog input channels for the A/D converter, or they serve as timer inputs:		
P5.0	76	I	AN0		
P5.1	77	I	AN1		
P5.2	78	I	AN2		
P5.3	79	I	AN3		
P5.4	2	I	AN4,	T2EUD	GPT1 Timer T2 Ext. Up/Down Ctrl. Inp.
P5.5	3	I	AN5,	T4EUD	GPT1 Timer T4 Ext. Up/Down Ctrl. Inp.
P5.6	4	I	AN6,	T2IN	GPT1 Timer T2 Input for Count/Gate/Reload/Capture
P5.7	5	I	AN7,	T4IN	GPT1 Timer T4 Input for Count/Gate/Reload/Capture
P3		IO	Port 3 is a 9-bit bidirectional I/O port. It is bit-wise programmable for input or output via direction bits. For a pin configured as input, the output driver is put into high-impedance state. Port 3 outputs can be configured as push/pull or open drain drivers. The input threshold of Port 3 is selectable (TTL or special). The following Port 3 pins also serve for alternate functions:		
P3.4	8	I	T3EUD	GPT1 Timer T3 External Up/Down Control Input	
P3.6	9	I	T3IN	GPT1 Timer T3 Count/Gate Input	
P3.8	10	I/O	MRST	SSC Master-Receive/Slave-Transmit Inp./Outp.	
P3.9	11	I/O	MTSR	SSC Master-Transmit/Slave-Receive Outp./Inp.	
P3.10	12	O	TxD0	ASC0 Clock/Data Output (Async./Sync.)	
P3.11	13	I/O	RxD0	ASC0 Data Input (Async.) or Inp./Outp. (Sync.)	
P3.12	14	O	$\overline{\text{BHE}}$	External Memory High Byte Enable Signal,	
		O	$\overline{\text{WRH}}$	External Memory High Byte Write Strobe	
P3.13	15	I/O	SCLK	SSC Master Clock Output / Slave Clock Input.	
P3.15	16	O	CLKOUT	System Clock Output (= CPU Clock),	
		O	FOUT	Programmable Frequency Output	

Table 2 Pin Definitions and Functions (cont'd)

Symbol	Pin No.	Input Outp.	Function
P8		IO	Port 8 is a 4-bit bidirectional I/O port. It is bit-wise programmable for input or output via direction bits. For a pin configured as input, the output driver is put into high-impedance state. Port 8 outputs can be configured as push/pull or open drain drivers. The input threshold of Port 8 is selectable (TTL or special). Port 8 pins provide inputs/outputs for CAPCOM2 and serial interface lines.[1)]
P8.0	72	I/O I	CC16IO CAPCOM2: CC16 Capture Inp./Compare Outp., CAN1_RxD CAN 1 Receive Data Input
P8.1	73	I/O O	CC17IO CAPCOM2: CC17 Capture Inp./Compare Outp., CAN1_TxD CAN 1 Transmit Data Output
P8.2	74	I/O I	CC18IO CAPCOM2: CC18 Capture Inp./Compare Outp., CAN1_RxD CAN 1 Receive Data Input
P8.3	75	I/O O	CC19IO CAPCOM2: CC19 Capture Inp./Compare Outp., CAN1_TxD CAN 1 Transmit Data Output
V_{AREF}	1	–	Reference voltage for the A/D converter.
V_{AGND}	80	–	Reference ground for the A/D converter.
V_{DD}	7, 21, 40, 53, 61	–	Digital Supply Voltage: +5 V during normal operation and idle mode. ≥2.5 V during power down mode.
V_{SS}	6, 20, 41, 56, 60	–	Digital Ground.

1) The CAN interface lines are assigned to ports P4 and P8 under software control. Within the CAN module several assignments can be selected.

Note: The following behavioural differences must be observed when the bidirectional reset is active:

- Bit BDRSTEN in register SYSCON cannot be changed after EINIT and is cleared automatically after a reset.
- The reset indication flags always indicate a long hardware reset.
- The PORT0 configuration is treated as if it were a hardware reset. In particular, the bootstrap loader may be activated when P0L.4 is low.
- Pin $\overline{\text{RSTIN}}$ may only be connected to external reset devices with an open drain output driver.
- A short hardware reset is extended to the duration of the internal reset sequence.

Central Processing Unit (CPU)

The main core of the CPU consists of a 4-stage instruction pipeline, a 16-bit arithmetic and logic unit (ALU) and dedicated SFRs. Additional hardware has been spent for a separate multiply and divide unit, a bit-mask generator and a barrel shifter.

Based on these hardware provisions, most of the C164CI's instructions can be executed in just one machine cycle which requires 2 CPU clocks (4 TCL). For example, shift and rotate instructions are always processed during one machine cycle independent of the number of bits to be shifted. All multiple-cycle instructions have been optimized so that they can be executed very fast as well: branches in 2 cycles, a 16 × 16 bit multiplication in 5 cycles and a 32-/16-bit division in 10 cycles. Another pipeline optimization, the so-called 'Jump Cache', reduces the execution time of repeatedly performed jumps in a loop from 2 cycles to 1 cycle.

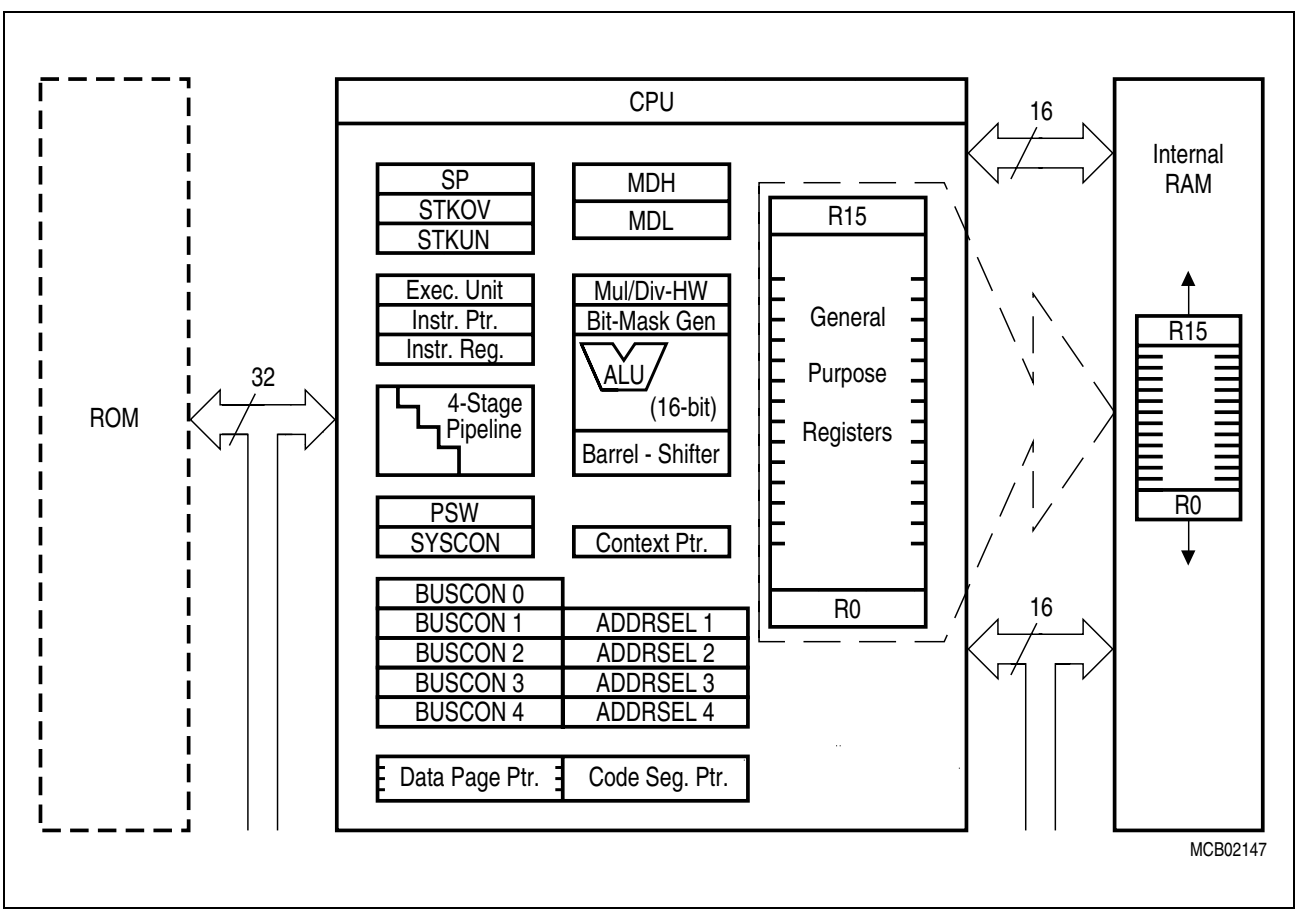


Figure 4 CPU Block Diagram

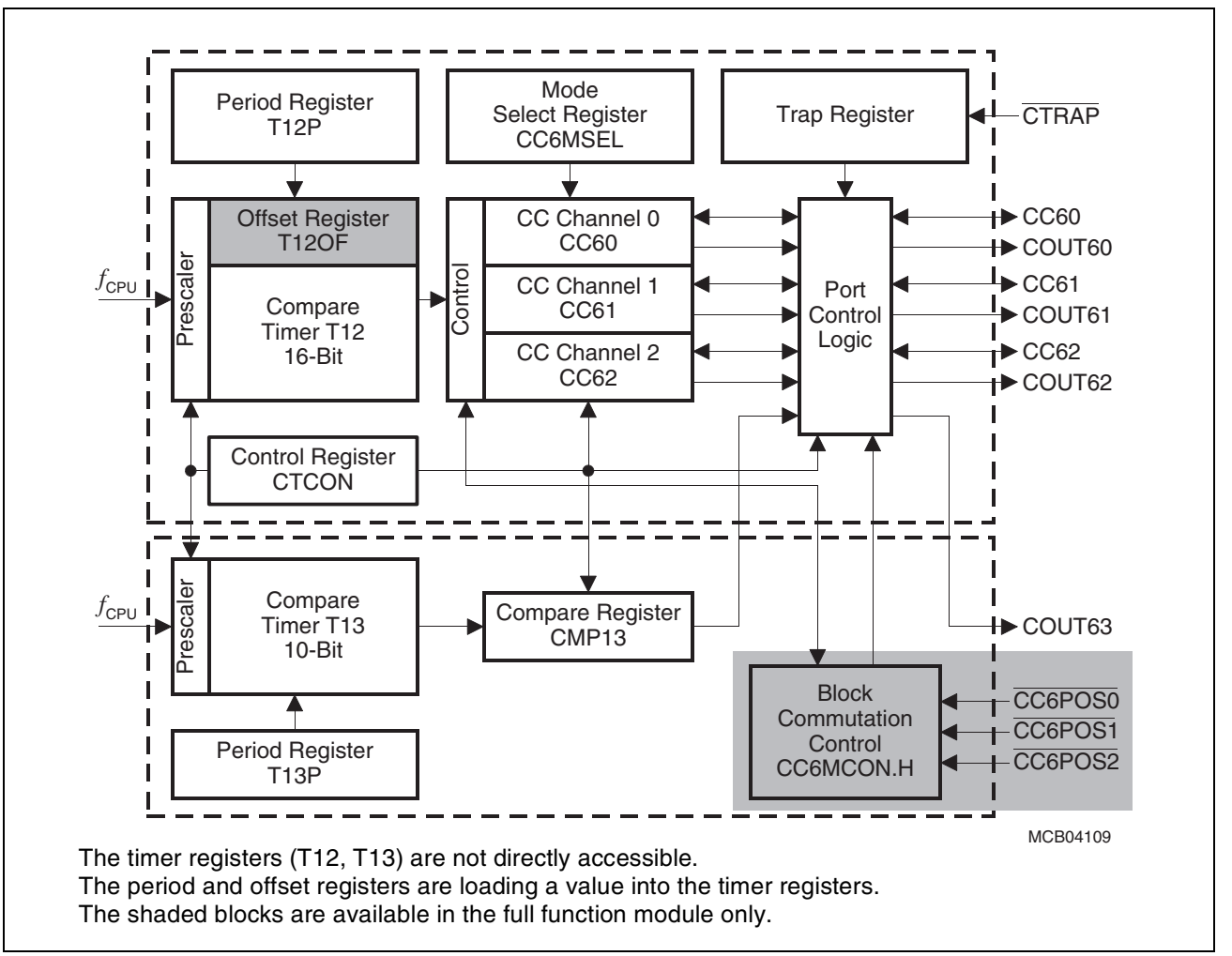
Table 3 C164CI Interrupt Nodes (cont'd)

Source of Interrupt or PEC Service Request	Request Flag	Enable Flag	Interrupt Vector	Vector Location	Trap Number
CAPCOM 6 Timer 12	T12IR	T12IE	T12INT	$00'0134_H$	$4D_H$
CAPCOM 6 Timer 13	T13IR	T13IE	T13INT	$00'0138_H$	$4E_H$
CAPCOM 6 Emergency	CC6EIR	CC6EIE	CC6EINT	$00'013C_H$	$4F_H$

The Capture/Compare Unit CAPCOM6

The CAPCOM6 unit supports generation and control of timing sequences on up to three 16-bit capture/compare channels plus one 10-bit compare channel.
In compare mode the CAPCOM6 unit provides two output signals per channel which have inverted polarity and non-overlapping pulse transitions. The compare channel can generate a single PWM output signal and is further used to modulate the capture/compare output signals.
In capture mode the contents of compare timer 12 is stored in the capture registers upon a signal transition at pins CCx.

Compare timers T12 (16-bit) and T13 (10-bit) are free running timers which are clocked by the prescaled CPU clock.



The timer registers (T12, T13) are not directly accessible.
The period and offset registers are loading a value into the timer registers.
The shaded blocks are available in the full function module only.

Figure 5 CAPCOM6 Block Diagram

For motor control applications both subunits may generate versatile multichannel PWM signals which are basically either controlled by compare timer 12 or by a typical hall sensor pattern at the interrupt inputs (block commutation).

Note: Multichannel signal generation is provided only in devices with a full CAPCOM6.

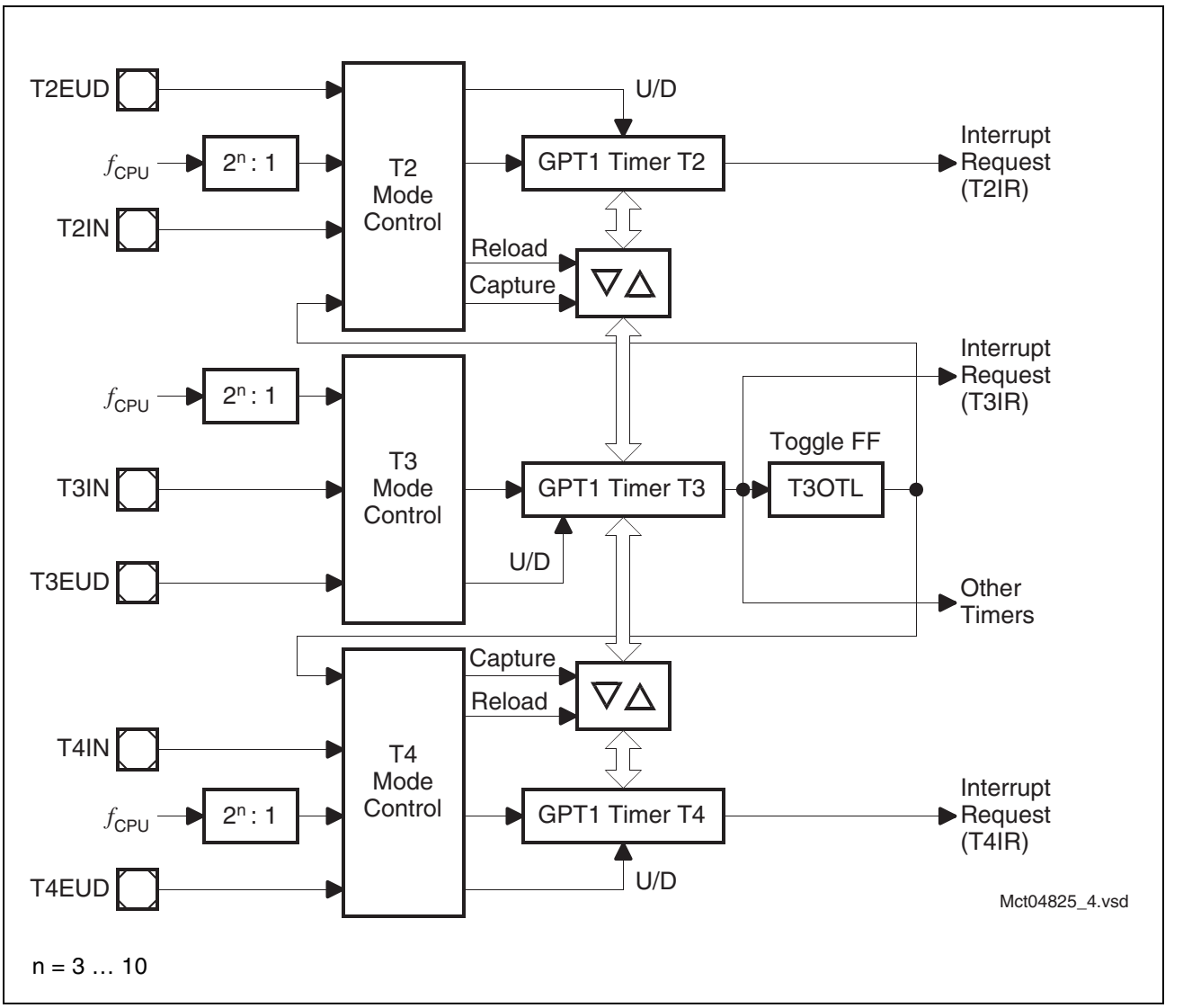


Figure 6 Block Diagram of GPT1

A/D Converter

For analog signal measurement, a 10-bit A/D converter with 8 multiplexed input channels and a sample and hold circuit has been integrated on-chip. It uses the method of successive approximation. The sample time (for loading the capacitors) and the conversion time is programmable and can so be adjusted to the external circuitry.

Overrun error detection/protection is provided for the conversion result register (ADDAT): either an interrupt request will be generated when the result of a previous conversion has not been read from the result register at the time the next conversion is complete, or the next conversion is suspended in such a case until the previous result has been read.

For applications which require less than 8 analog input channels, the remaining channel inputs can be used as digital input port pins.

The A/D converter of the C164CI supports four different conversion modes. In the standard Single Channel conversion mode, the analog level on a specified channel is sampled once and converted to a digital result. In the Single Channel Continuous mode, the analog level on a specified channel is repeatedly sampled and converted without software intervention. In the Auto Scan mode, the analog levels on a prespecified number of channels (standard or extension) are sequentially sampled and converted. In the Auto Scan Continuous mode, the number of prespecified channels is repeatedly sampled and converted. In addition, the conversion of a specific channel can be inserted (injected) into a running sequence without disturbing this sequence. This is called Channel Injection Mode.

The Peripheral Event Controller (PEC) may be used to automatically store the conversion results into a table in memory for later evaluation, without requiring the overhead of entering and exiting interrupt routines for each data transfer.

After each reset and also during normal operation the ADC automatically performs calibration cycles. This automatic self-calibration constantly adjusts the converter to changing operating conditions (e.g. temperature) and compensates process variations.

These calibration cycles are part of the conversion cycle, so they do not affect the normal operation of the A/D converter.

In order to decouple analog inputs from digital noise and to avoid input trigger noise those pins used for analog input can be disconnected from the digital IO or input stages under software control. This can be selected for each pin separately via register P5DIDIS (Port 5 Digital Input Disable).

Power Management

The C164CI provides several means to control the power it consumes either at a given time or averaged over a certain timespan. Three mechanisms can be used (partly in parallel):

- **Power Saving Modes** switch the C164CI into a special operating mode (control via instructions).
  Idle Mode stops the CPU while the peripherals can continue to operate.
  Sleep Mode and Power Down Mode stop all clock signals and all operation (RTC may optionally continue running). Sleep Mode can be terminated by external interrupt signals.
- **Clock Generation Management** controls the distribution and the frequency of internal and external clock signals (control via register SYSCON2).
  Slow Down Mode lets the C164CI run at a CPU clock frequency of f_{OSC}/1 … 32 (half for prescaler operation) which drastically reduces the consumed power. The PLL can be optionally disabled while operating in Slow Down Mode.
  External circuitry can be controlled via the programmable frequency output FOUT.
- **Peripheral Management** permits temporary disabling of peripheral modules (control via register SYSCON3).
  Each peripheral can separately be disabled/enabled. A group control option disables a major part of the peripheral set by setting one single bit.

The on-chip RTC supports intermittend operation of the C164CI by generating cyclic wakeup signals. This offers full performance to quickly react on action requests while the intermittend sleep phases greatly reduce the average power consumption of the system.

Instruction Set Summary

Table 6 lists the instructions of the C164CI in a condensed way.
The various addressing modes that can be used with a specific instruction, the operation of the instructions, parameters for conditional execution of instructions, and the opcodes for each instruction can be found in the **“C166 Family Instruction Set Manual”**.

This document also provides a detailled description of each instruction.

Table 6 Instruction Set Summary

Mnemonic	Description	Bytes
ADD(B)	Add word (byte) operands	2 / 4
ADDC(B)	Add word (byte) operands with Carry	2 / 4
SUB(B)	Subtract word (byte) operands	2 / 4
SUBC(B)	Subtract word (byte) operands with Carry	2 / 4
MUL(U)	(Un)Signed multiply direct GPR by direct GPR (16-16-bit)	2
DIV(U)	(Un)Signed divide register MDL by direct GPR (16-/16-bit)	2
DIVL(U)	(Un)Signed long divide reg. MD by direct GPR (32-/16-bit)	2
CPL(B)	Complement direct word (byte) GPR	2
NEG(B)	Negate direct word (byte) GPR	2
AND(B)	Bitwise AND, (word/byte operands)	2 / 4
OR(B)	Bitwise OR, (word/byte operands)	2 / 4
XOR(B)	Bitwise XOR, (word/byte operands)	2 / 4
BCLR	Clear direct bit	2
BSET	Set direct bit	2
BMOV(N)	Move (negated) direct bit to direct bit	4
BAND, BOR, BXOR	AND/OR/XOR direct bit with direct bit	4
BCMP	Compare direct bit to direct bit	4
BFLDH/L	Bitwise modify masked high/low byte of bit-addressable direct word memory with immediate data	4
CMP(B)	Compare word (byte) operands	2 / 4
CMPD1/2	Compare word data to GPR and decrement GPR by 1/2	2 / 4
CMPI1/2	Compare word data to GPR and increment GPR by 1/2	2 / 4
PRIOR	Determine number of shift cycles to normalize direct word GPR and store result in direct word GPR	2
SHL / SHR	Shift left/right direct word GPR	2
ROL / ROR	Rotate left/right direct word GPR	2
ASHR	Arithmetic (sign bit) shift right direct word GPR	2

Table 7 C164CI Registers, Ordered by Name (cont'd)

Name	Physical Address	8-Bit Addr.	Description	Reset Value
CC26IC b	$F174_H$ **E**	BA_H	CAPCOM Reg. 26 Interrupt Ctrl. Reg.	0000_H
CC27	$FE76_H$	$3B_H$	CAPCOM Register 27	0000_H
CC27IC b	$F176_H$ **E**	BB_H	CAPCOM Reg. 27 Interrupt Ctrl. Reg.	0000_H
CC28	$FE78_H$	$3C_H$	CAPCOM Register 28	0000_H
CC28IC b	$F178_H$ **E**	BC_H	CAPCOM Reg. 28 Interrupt Ctrl. Reg.	0000_H
CC29	$FE7A_H$	$3D_H$	CAPCOM Register 29	0000_H
CC29IC b	$F184_H$ **E**	$C2_H$	CAPCOM Reg. 29 Interrupt Ctrl. Reg.	0000_H
CC30	$FE7C_H$	$3E_H$	CAPCOM Register 30	0000_H
CC30IC b	$F18C_H$ **E**	$C6_H$	CAPCOM Reg. 30 Interrupt Ctrl. Reg.	0000_H
CC31	$FE7E_H$	$3F_H$	CAPCOM Register 31	0000_H
CC31IC b	$F194_H$ **E**	CA_H	CAPCOM Reg. 31 Interrupt Ctrl. Reg.	0000_H
CC60	$FE30_H$	18_H	CAPCOM 6 Register 0	0000_H
CC61	$FE32_H$	19_H	CAPCOM 6 Register 1	0000_H
CC62	$FE34_H$	$1A_H$	CAPCOM 6 Register 2	0000_H
CC6EIC b	$F188_H$ **E**	$C4_H$	CAPCOM 6 Emergency Interrrupt Control Register	0000_H
CC6CIC b	$F17E_H$ **E**	BF_H	CAPCOM 6 Interrupt Control Register	0000_H
CC6MCON b	$FF32_H$	99_H	CAPCOM 6 Mode Control Register	$00FF_H$
CC6MIC b	$FF36_H$	$9B_H$	CAPCOM 6 Mode Interrupt Ctrl. Reg.	0000_H
CC6MSEL	$F036_H$ **E**	$1B_H$	CAPCOM 6 Mode Select Register	0000_H
CC8IC b	$FF88_H$	$C4_H$	External Interrupt 0 Control Register	0000_H
CC9IC b	$FF8A_H$	$C5_H$	External Interrupt 1 Control Register	0000_H
CCM4 b	$FF22_H$	91_H	CAPCOM Mode Control Register 4	0000_H
CCM5 b	$FF24_H$	92_H	CAPCOM Mode Control Register 5	0000_H
CCM6 b	$FF26_H$	93_H	CAPCOM Mode Control Register 6	0000_H
CCM7 b	$FF28_H$	94_H	CAPCOM Mode Control Register 7	0000_H
CMP13	$FE36_H$	$1B_H$	CAPCOM 6 Timer 13 Compare Reg.	0000_H
CP	$FE10_H$	08_H	CPU Context Pointer Register	$FC00_H$
CSP	$FE08_H$	04_H	CPU Code Segment Pointer Register (8 bits, not directly writeable)	0000_H

Parameter Interpretation

The parameters listed in the following partly represent the characteristics of the C164CI and partly its demands on the system. To aid in interpreting the parameters right, when evaluating them for a design, they are marked in column “Symbol”:

CC (**C**ontroller **C**haracteristics):
The logic of the C164CI will provide signals with the respective characteristics.

SR (**S**ystem **R**equirement):
The external system must provide signals with the respective characteristics to the C164CI.

DC Characteristics

(Operating Conditions apply)[1)]

Parameter	Symbol		Limit Values		Unit	Test Conditions
			min.	max.		
Input low voltage (TTL, all except XTAL1)	V_{IL}	SR	-0.5	0.2 V_{DD} - 0.1	V	–
Input low voltage XTAL1	V_{IL2}	SR	-0.5	0.3 V_{DD}	V	–
Input low voltage (Special Threshold)	V_{ILS}	SR	-0.5	2.0	V	–
Input high voltage (TTL, all except $\overline{\text{RSTIN}}$, XTAL1)	V_{IH}	SR	0.2 V_{DD} + 0.9	V_{DD} + 0.5	V	–
Input high voltage $\overline{\text{RSTIN}}$ (when operated as input)	V_{IH1}	SR	0.6 V_{DD}	V_{DD} + 0.5	V	–
Input high voltage XTAL1	V_{IH2}	SR	0.7 V_{DD}	V_{DD} + 0.5	V	–
Input high voltage (Special Threshold)	V_{IHS}	SR	0.8 V_{DD} - 0.2	V_{DD} + 0.5	V	–
Input Hysteresis (Special Threshold)	HYS		400	–	mV	Series resistance = 0 Ω
Output low voltage[2)]	V_{OL}	CC	–	1.0	V	$I_{OL} \le I_{OLmax}$[3)]
			–	0.45	V	$I_{OL} \le I_{OLnom}$[3)4)]
Output high voltage[5)]	V_{OH}	CC	V_{DD} - 1.0	–	V	$I_{OH} \ge I_{OHmax}$[3)]
			V_{DD} - 0.45	–	V	$I_{OH} \ge I_{OHnom}$[3)4)]
Input leakage current (Port 5)	I_{OZ1}	CC	–	±200	nA	0 V < V_{IN} < V_{DD}

Table 10 Current Limits for Port Output Drivers

Port Output Driver Mode	Maximum Output Current (I_{OLmax}, $-I_{OHmax}$)[1]	Nominal Output Current (I_{OLnom}, $-I_{OHnom}$)[2]
Strong driver	10 mA	2.5 mA
Medium driver	4.0 mA	1.0 mA
Weak driver	0.5 mA	0.1 mA

1) An output current above $|I_{OXnom}|$ may be drawn from up to three pins at the same time. For any group of 16 neighboring port output pins the total output current in each direction (ΣI_{OL} and $\Sigma -I_{OH}$) must remain below 50 mA.

2) The current ROM-version of the C164CI (step Ax) is equipped with port drivers, which provide reduced driving capability and reduced control. Please refer to the actual errata sheet for details.

Power Consumption C164CI (ROM)

(Operating Conditions apply)

Parameter	Sym-bol	Limit Values		Unit	Test Conditions
		min.	max.		
Power supply current (active) with all peripherals active	I_{DD}	–	1 + 2.5 × f_{CPU}	mA	$\overline{RSTIN}$ = V_{IL} f_{CPU} in [MHz][1]
Idle mode supply current with all peripherals active	I_{IDX}	–	1 + 1.1 × f_{CPU}	mA	$\overline{RSTIN}$ = V_{IH1} f_{CPU} in [MHz][1]
Idle mode supply current with all peripherals deactivated, PLL off, SDD factor = 32	I_{IDO}[2]	–	500 + 50 × f_{OSC}	µA	$\overline{RSTIN}$ = V_{IH1} f_{OSC} in [MHz][1]
Sleep and Power-down mode supply current with RTC running	I_{PDR}[2]	–	200 + 25 × f_{OSC}	µA	V_{DD} = V_{DDmax} f_{OSC} in [MHz][3]
Sleep and Power-down mode supply current with RTC disabled	I_{PDO}	–	50	µA	V_{DD} = V_{DDmax}[3]

1) The supply current is a function of the operating frequency. This dependency is illustrated in **Figure 9**. These parameters are tested at V_{DDmax} and maximum CPU clock with all outputs disconnected and all inputs at V_{IL} or V_{IH}.

2) This parameter is determined mainly by the current consumed by the oscillator (see **Figure 8**). This current, however, is influenced by the external oscillator circuitry (crystal, capacitors). The values given refer to a typical circuitry and may change in case of a not optimized external oscillator circuitry.

3) This parameter is tested including leakage currents. All inputs (including pins configured as inputs) at 0 V to 0.1 V or at V_{DD} - 0.1 V to V_{DD}, V_{REF} = 0 V, all outputs (including pins configured as outputs) disconnected.

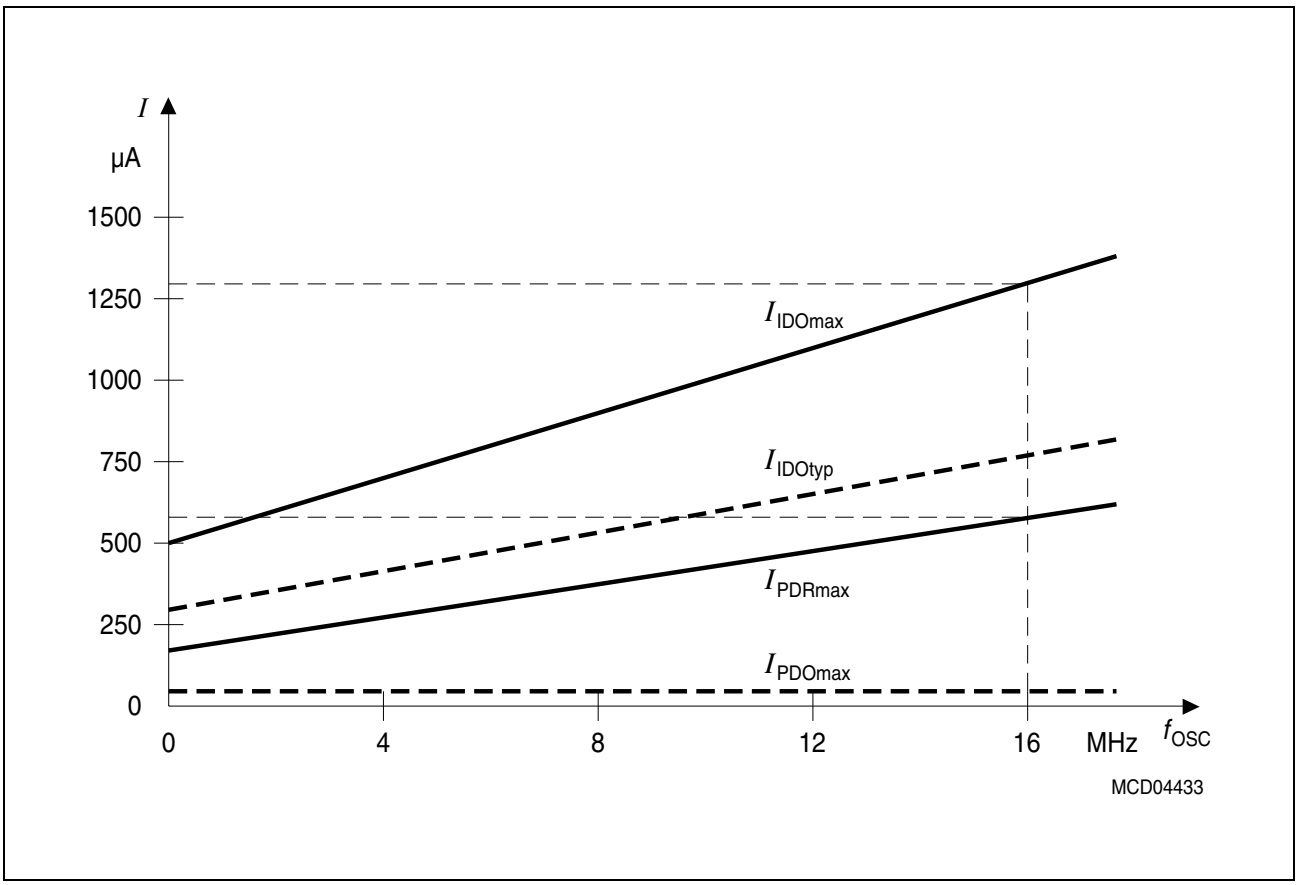


Figure 8 **Idle and Power Down Supply Current as a Function of Oscillator Frequency**

Direct Drive

When direct drive is configured (CLKCFG = 011_B) the on-chip phase locked loop is disabled and the CPU clock is directly driven from the internal oscillator with the input clock signal.
The frequency of f_{CPU} directly follows the frequency of f_{OSC} so the high and low time of f_{CPU} (i.e. the duration of an individual TCL) is defined by the duty cycle of the input clock f_{OSC}.
The timings listed below that refer to TCLs therefore must be calculated using the minimum TCL that is possible under the respective circumstances. This minimum value can be calculated via the following formula:

$$TCL_{min} = 1/f_{OSC} \times DC_{min} \qquad \text{(DC = duty cycle)}$$

For two consecutive TCLs the deviation caused by the duty cycle of f_{OSC} is compensated so the duration of 2TCL is always $1/f_{OSC}$. The minimum value TCL_{min} therefore has to be used only once for timings that require an odd number of TCLs (1, 3, …). Timings that require an even number of TCLs (2, 4, …) may use the formula $2TCL = 1/f_{OSC}$.

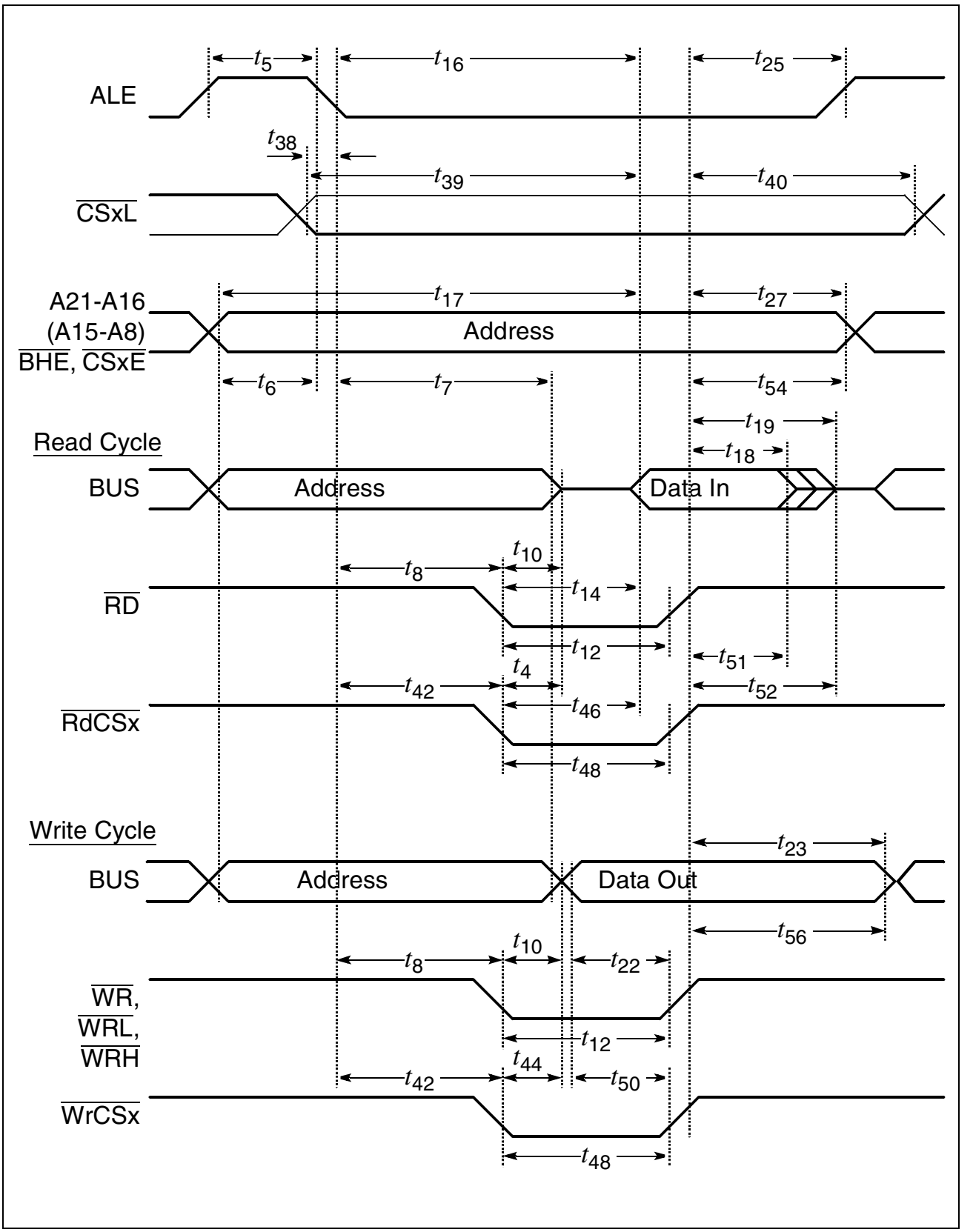


Figure 17 External Memory Cycle:
Multiplexed Bus, With Read/Write Delay, Extended ALE

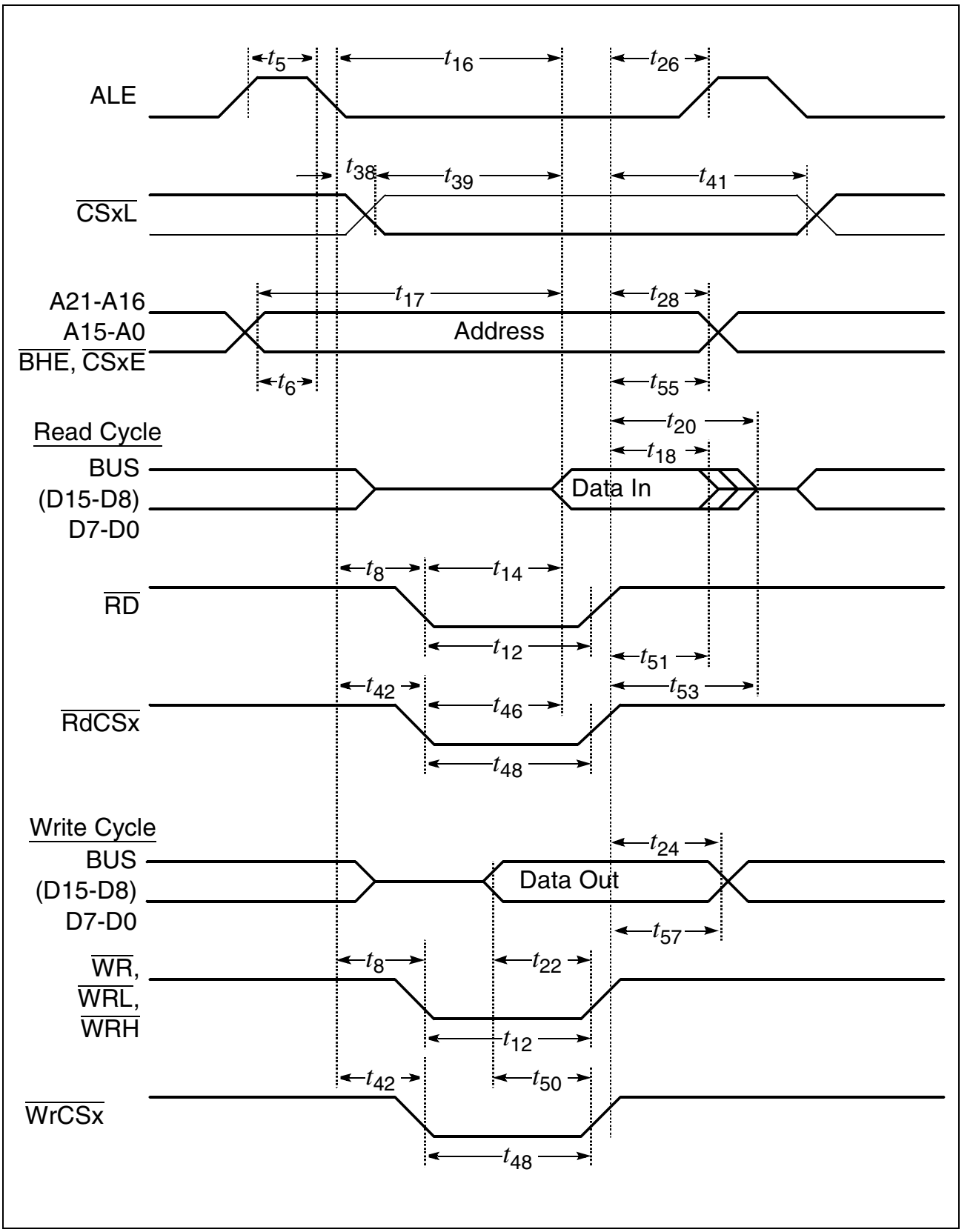


Figure 20 External Memory Cycle:
Demultiplexed Bus, With Read/Write Delay, Normal ALE

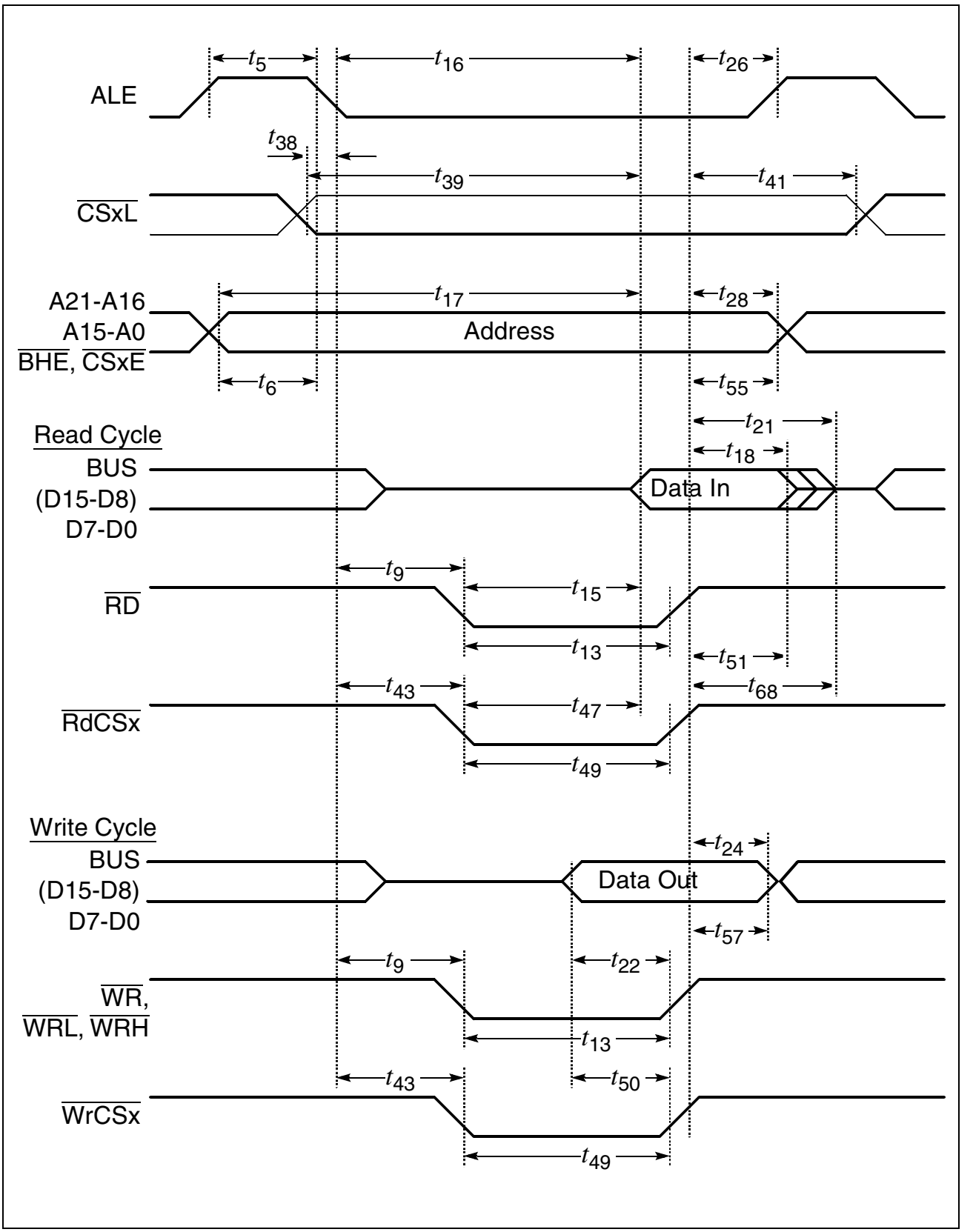
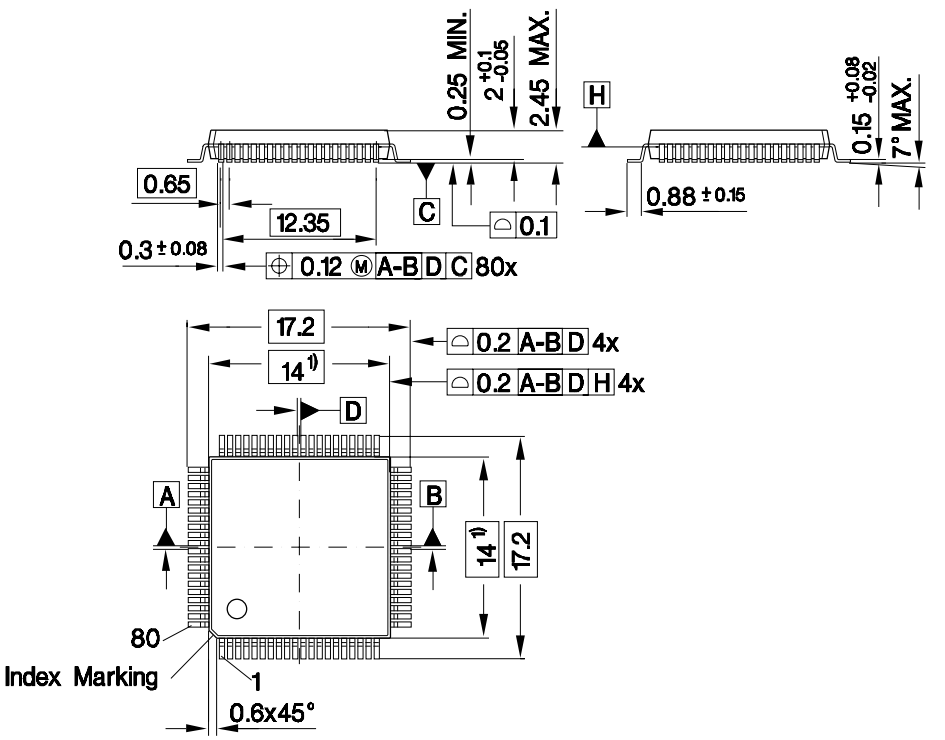


Figure 23 External Memory Cycle:
Demultiplexed Bus, No Read/Write Delay, Extended ALE

Package Outlines

P-MQFP-80-7
(Plastic Metric Quad Flat Package)



1) Does not include plastic or metal protrusion of 0.25 max. per side

GPM05249

Sorts of Packing
Package outlines for tubes, trays etc. are contained in our Data Book “Package Information”.

SMD = Surface Mounted Device

Dimensions in mm